

Zero-Drift, Rail-to-Rail I/O CMOS Operational Amplifiers

FEATURES

- **Low Offset Voltage:** $\pm 1\mu\text{V}$ (TYP)
- **Input Offset Drift:** $\pm 0.005\mu\text{V}/^\circ\text{C}$
- **High Gain Bandwidth Product:** 4.5MHz
- **Rail-to-Rail Input and Output**
- **High Gain, CMRR, PSRR:** 130dB
- **High Slew Rate:** 2.7V/us
- **Low Noise:** 0.75uVp-p (0.01Hz ~ 10Hz)
- **Low Power Consumption:** 640uA /op amp
- **Overload Recovery Time:** 1us
- **Low Supply Voltage:** +2.7V to +5.5V
- **No External Capacitors Required**
- **Extended Temperature:** -40°C to +125°C

APPLICATIONS

- **Temperature Sensors**
- **Medical/ Industrial Instrumentation**
- **Pressure Sensors**
- **Battery-Powered Instrumentation**
- **Active Filtering**
- **Weight Scale Sensor**
- **Strain Gage Amplifiers**
- **Power Converter/ Inverter**

DESCRIPTION

The RS8551, RS8552, RS8554, RS8553 (dual version & shutdown) series of CMOS operational amplifiers use auto-zero techniques to simultaneously provide very low offset voltage (5uV max) and near-zero drift over time and temperature. This family of amplifiers has ultralow noise, offset and power.

This miniature, high-precision operational amplifiers offset high input impedance and rail-to-rail input and rail-to-rail output swing. With high gain-bandwidth product of 4.5MHz and slew rate of 2.7V/us.

Single or dual supplies as low as +2.7V ($\pm 1.35\text{V}$) and up to +5.5V ($\pm 2.75\text{V}$) may be used.

The RS8551/ RS8552/ RS8554/ RS8553 (dual version with shutdown) are specified for the extended industrial and automotive temperature range (-40°C to 125°C). The RS8551 single amplifier is available in 5-lead SOT23, 8-lead MSOP8 and 8-lead SOIC packages, The RS8552 dual amplifier is available in 8-lead SOIC, 8-lead DFN2x2 and 8-lead TSSOP narrow surface mount packages, The RS8553 (dual version with shutdown) comes in Micro-SIZE MSOP-10. The RS8554 quad is available in 14-lead SOIC and 14-lead narrow TSSOP packages.

Device Information ⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE(NOM)
RS8551	SOT23-5	2.90mm×1.60mm
	SOIC-8 (SOP8)	4.90mm×3.90mm
	MSOP-8	3.00mm×3.00mm
RS8552	SOIC-8 (SOP8)	4.90mm×3.90mm
	MSOP-8	3.00mm×3.00mm
	DFN2x2-8L	2.00mm×2.00mm
RS8553	MSOP-10	3.00mm×3.00mm
RS8554	SOIC-14 (SOP14)	8.65mm×3.90mm
	TSSOP-14	5.00mm×4.40mm

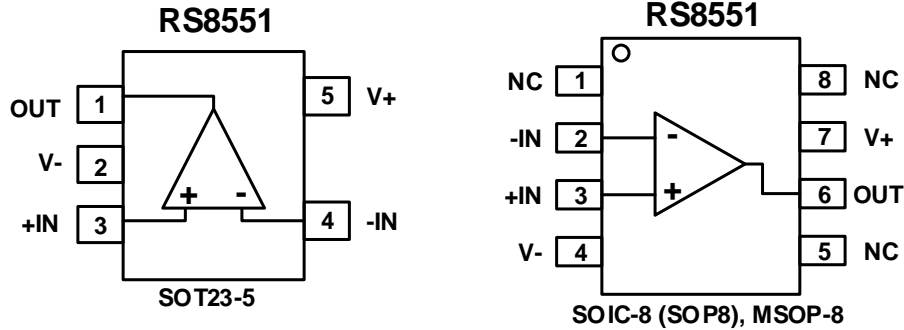
(1) For all available packages, see the orderable addendum at the end of the data sheet.

Revision History

Note: Page numbers for previous revisions may differ from page numbers in the current version.

Version	Change Date	Change Item
C.1	2022/05/17	1. Update Package Qty on Page 3@RevB.6 2. Added TAPE AND REEL INFORMATION 3. Added APPLICATION NOTE

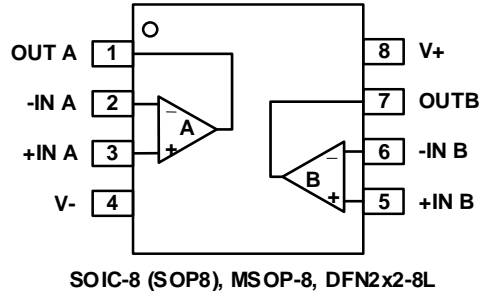
Pin Configuration and Functions (Top View)



Pin Description

NAME	PIN		I/O	DESCRIPTION
	SOT23-5	SOIC-8 (SOP8)/ MSOP8		
-IN	4	2	I	Negative (inverting) input
+IN	3	3	I	Positive (noninverting) input
NC	-	1,5,8	-	No internal connection (can be left floating)
OUT	1	6	O	Output
V-	2	4	-	Negative (lowest) power supply
V+	5	7	-	Positive (highest) power supply

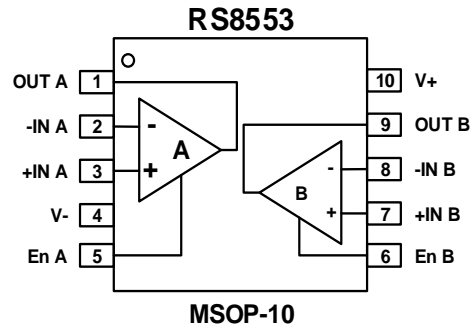
RS8552



Pin Description

NAME	PIN		I/O	DESCRIPTION
	SOIC-8(SOP8) /MSOP8/ DFN2x2-8L			
-INA		2	I	Inverting input, channel A
+INA		3	I	Noninverting input, channel A
-INB		6	I	Inverting input, channel B
+INB		5	I	Noninverting input, channel B
OUTA		1	O	Output, channel A
OUTB		7	O	Output, channel B
V-		4	-	Negative (lowest) power supply
V+		8	-	Positive (highest) power supply

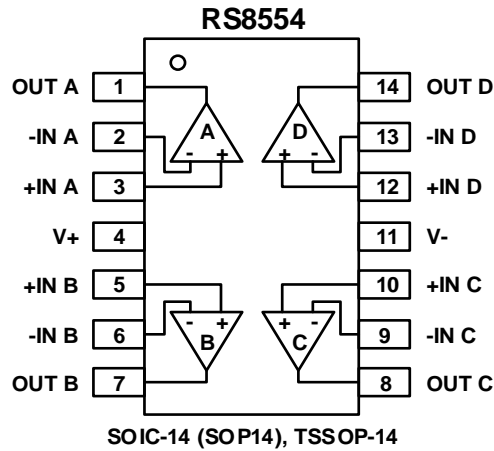
Pin Configuration and Functions (Top View)



Pin Description

NAME	PIN	I/O	DESCRIPTION
	MSOP-10		
-INA	2	I	Inverting input, channel A
+INA	3	I	Noninverting input, channel A
-INB	8	I	Inverting input, channel B
+INB	7	I	Noninverting input, channel B
EnA	5	I	Enable Input. A logic low reduces the supply current to 10Na. Connect to IN for normal operation, channel A
EnB	6	I	Enable Input. A logic low reduces the supply current to 10Na. Connect to IN for normal operation, channel B
OUTA	1	O	Output, channel A
OUTB	9	O	Output, channel B
V-	4	-	Negative (lowest) power supply
V+	10	-	Positive (highest) power supply

Pin Configuration and Functions (Top View)



Pin Description

NAME	PIN	I/O	DESCRIPTION
	SOIC-14 (SOP14)/ TSSOP-14		
-INA	2	I	Inverting input, channel A
+INA	3	I	Noninverting input, channel A
-INB	6	I	Inverting input, channel B
+INB	5	I	Noninverting input, channel B
-INC	9	I	Inverting input, channel C
+INC	10	I	Noninverting input, channel C
-IND	13	I	Inverting input, channel D
+IND	12	I	Noninverting input, channel D
OUTA	1	O	Output, channel A
OUTB	7	O	Output, channel B
OUTC	8	O	Output, channel C
OUTD	14	O	Output, channel D
V-	11	-	Negative (lowest) power supply
V+	4	-	Positive (highest) power supply

SPECIFICATIONS

Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		MIN	MAX	UNIT
Voltage	Supply, $V_S=(V+) - (V-)$		7	V
	Signal input pin ⁽²⁾	(V-)-0.5	(V+) +0.5	
	Signal output pin ⁽³⁾	(V-)-0.5	(V+) +0.5	
Current	Signal input pin ⁽²⁾	-10	10	Ma
	Signal output pin ⁽³⁾	-55	55	Ma
	Output short-circuit ⁽⁴⁾	Continuous		
Temperature	Operating range, T_A	-40	125	°C
	Junction, T_J	-40	150	
	Storage, T_{stg}	-65	150	

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10Ma or less.

(3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ± 55 Ma or less.

(4) Short-circuit to ground, one amplifier per package.

ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-body model (HBM)	± 5000	V
	Machine Model (MM)	± 400	

Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, $V_S= (V+) - (V-)$	Single-supply	2.7		5.5	V
	Dual-supply	± 1.35		± 2.75	

Thermal Information: RS8551

THERMAL METRIC		RS8551			UNIT
		5PINS	8PINS		
		SOT23-5	SOIC-8(SOP8)	MSOP-8	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	273.8	116	165	°C/W
$R_{\theta JC (top)}$	Junction-to-case(top) thermal resistance	126.8	60	53	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	85.9	56	87	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	10.9	12.8	4.9	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	84.9	98.3	85	°C/W
$R_{\theta JC (bot)}$	Junction-to-case(bottom) thermal resistance	N/A	N/A	N/A	°C/W

Thermal Information: RS8552

THERMAL METRIC		RS8552			UNIT
		8PINS			
		SOIC-8 (SOP8)	MSOP8	DFN2x2-8L	
R _{θJA}	Junction-to-ambient thermal resistance	116	165	80.1	°C/W
R _{θJC (top)}	Junction-to-case (top) thermal resistance	60	53	100	°C/W
R _{θJB}	Junction-to-board thermal resistance	56	87	45	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	12.8	4.9	6.8	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	98.3	85	45.2	°C/W
R _{θJC (bot)}	Junction-to-case (bottom) thermal resistance	N/A	N/A	22.7	°C/W

Thermal Information: RS8553

THERMAL METRIC		RS8553		UNIT
		10PINS		
		MSOP-10		
R _{θJA}	Junction-to-ambient thermal resistance	169.5		°C/W
R _{θJC (top)}	Junction-to-case (top) thermal resistance	84.1		°C/W
R _{θJB}	Junction-to-board thermal resistance	113		°C/W
Ψ _{JT}	Junction-to-top characterization parameter	15.8		°C/W
Ψ _{JB}	Junction-to-board characterization parameter	111.6		°C/W
R _{θJC (bot)}	Junction-to-case (bottom) thermal resistance	N/A		°C/W

Thermal Information: RS8554

THERMAL METRIC		RS8554		UNIT
		14PINS		
		SOIC-14	TSSOP-14	
R _{θJA}	Junction-to-ambient thermal resistance	83.8	120.8	°C/W
R _{θJC (top)}	Junction-to-case (top) thermal resistance	70.7	34.3	°C/W
R _{θJB}	Junction-to-board thermal resistance	59.5	62.8	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	11.6	1	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	37.7	56.5	°C/W
R _{θJC (bot)}	Junction-to-case (bottom) thermal resistance	N/A	N/A	°C/W

PACKAGE/ORDERING INFORMATION

Orderable Device	Package Type	Pin	Channel	Op Temp (°C)	Device Marking ⁽¹⁾	Package Qty
RS8551XF	SOT23-5	5	1	-40°C ~125°C	8551	Tape and Reel,3000
RS8551XK	SOIC-8 (SOP8)	8	1	-40°C ~125°C	RS8551	Tape and Reel,4000
RS8551XM	MSOP-8	8	1	-40°C ~125°C	RS8551	Tape and Reel,4000
RS8552XK	SOIC-8 (SOP8)	8	2	-40°C ~125°C	RS8552	Tape and Reel,4000
RS8552XM	MSOP-8	8	2	-40°C ~125°C	RS8552	Tape and Reel,4000
RS8552XTDE8	DFN2x2-8L	8	2	-40°C ~125°C	8552	Tape and Reel,3000
RS8553XN	MSOP-10	10	2	-40°C ~125°C	RS8553	Tape and Reel,4000
RS8554XP	SOIC-14(SOP14)	14	4	-40°C ~125°C	RS8554	Tape and Reel,4000
RS8554XQ	TSSOP-14	14	4	-40°C ~125°C	RS8554	Tape and Reel,4000

NOTE:

- (1) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.

ELECTRICAL CHARACTERISTICS

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$.

(At $T_A = +25^{\circ}\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITION	RS8551, RS8552, RS8553, RS8554			
			MIN	TYP	MAX	UNIT
OFFSET VOLTAGE						
Input Offset Voltage	V_{OS}	$V_{CM} = V_S/2$	-5	± 1	5	μV
Input Offset Voltage Average Drift	$V_{OS} T_C$			± 0.005	± 0.05	$\mu\text{V}/^{\circ}\text{C}$
Power-Supply Rejection Ratio	PSRR	$V_S = +2.7\text{V}$ to $+5.5\text{V}$, $V_{CM} = 0$	110	130		dB
Channel Separation, dc				0.1		$\mu\text{V}/\text{V}$
INPUT BIAS CURRENT						
Input Bias Current	I_B	$V_{CM} = V_S/2$		± 50		pA
Input Offset Current	I_{OS}			± 10		pA
NOISE PERFORMANCE						
Input Voltage Noise	$e_{n\text{p-p}}$	$f = 0.01\text{Hz}$ to 10Hz		0.75		μV_{pp}
Input Voltage Noise	$e_{n\text{p-p}}$	$f = 0.01\text{Hz}$ to 1Hz		0.22		μV_{pp}
Input Voltage Noise Density	e_n	$f = 1\text{KHz}$		35		$\text{nV}/\sqrt{\text{Hz}}$
Input Current Noise Density	i_n	$f = 10\text{Hz}$		1.5		$\text{fA}/\sqrt{\text{Hz}}$
INPUT VOLTAGE RANGE						
Common-Mode Voltage Range	V_{CM}		(V-) -0.1		(V+) +0.1	V
Common-Mode Rejection Ratio	CMRR	$(V-) -0.1\text{V} < V_{CM} < (V+) + 0.1\text{V}$	110	130		dB
INPUT CAPACITANCE						
Differential				1		pF
Common-Mode				5		pF
OPEN-LOOP GAIN						
Open-Loop Voltage Gain	A_{OL}	$R_L = 10\text{k}\Omega$, $V_O = 0.3\text{V}$ to 4.7V , $T_A = -40^{\circ}\text{C}$ to 125°C	110	130		dB
DYNAMIC PERFORMANCE						
Slew Rate	SR	$G = +1$		2.7		$\text{V}/\mu\text{s}$
Gain-Bandwidth Product	GBW			4.5		MHz
Overload Recovery Time				1		μs
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$R_L = 100\text{k}\Omega$ to GND	4.99	4.998		V
		$R_L = 10\text{k}\Omega$ to GND	4.95	4.98		V
Output Voltage Low	V_{OL}	$R_L = 100\text{k}\Omega$ to V+		1	10	mV
		$R_L = 10\text{k}\Omega$ to V+		10	30	mV
Short-Circuit Current	I_{SC}			50		mA
POWER SUPPLY						
Operating Voltage Range	V_S		2.7		5.5	V
Quiescent Current/ Amplifier	I_Q			640	870	μA
SHUTDOWN						
t_{OFF}				2		μs
t_{ON}				150		μs

V _L (shutdown)			0		+0.8	V
V _H (amplifier is active)			0.75 (V ₊)		V ₊	V
Input Bias Current of Enable Pin				50		pA
I _{QSD}				1	5	uA

TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

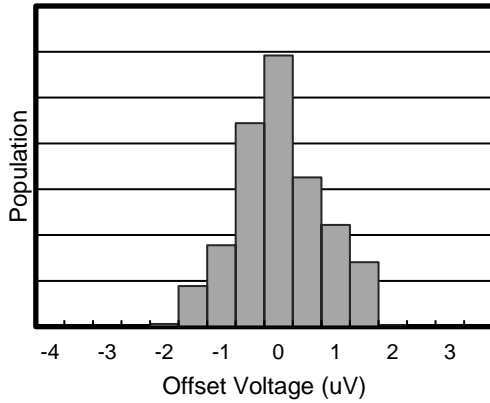


Figure 1. Offset Voltage Production Distribution

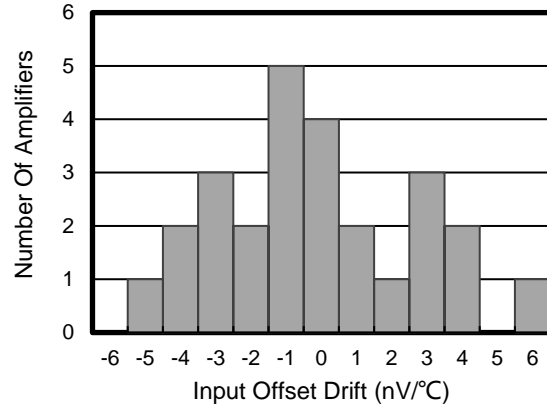


Figure 2. Offset Voltage Drift Production Distribution

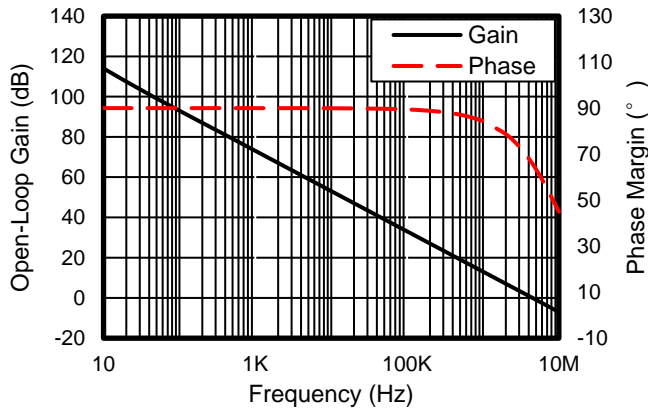


Figure 3. Open-Loop Gain and Phase vs Frequency

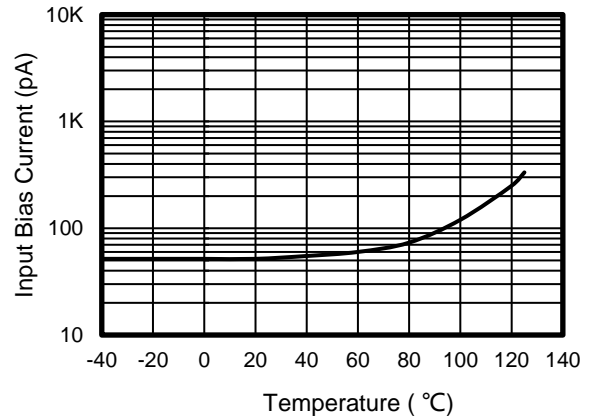


Figure 4. Input Bias Current vs Temperature

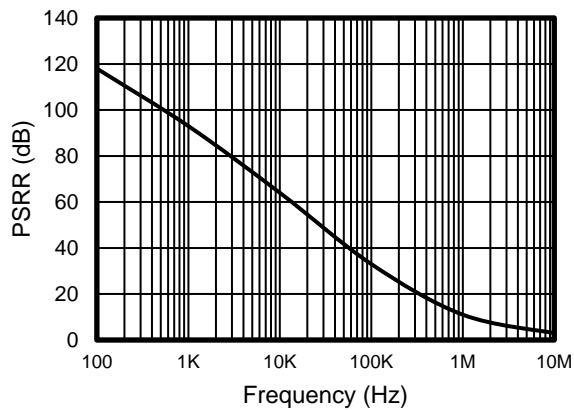


Figure 5. Power-Supply Rejection Ratio vs Frequency

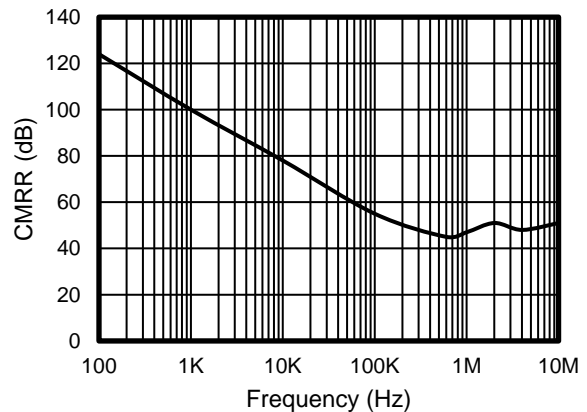


Figure 6. Common-Mode Rejection Ratio vs Frequency

TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

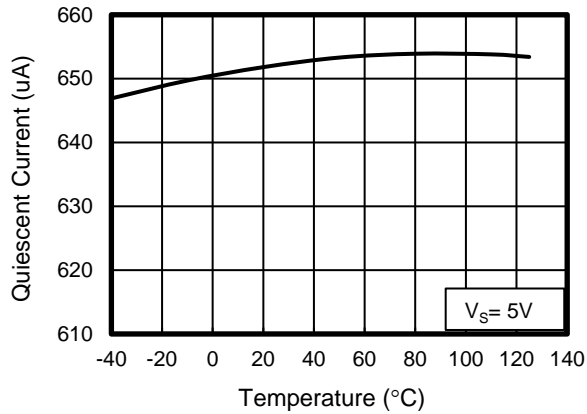


Figure 7. Quiescent Current vs Temperature

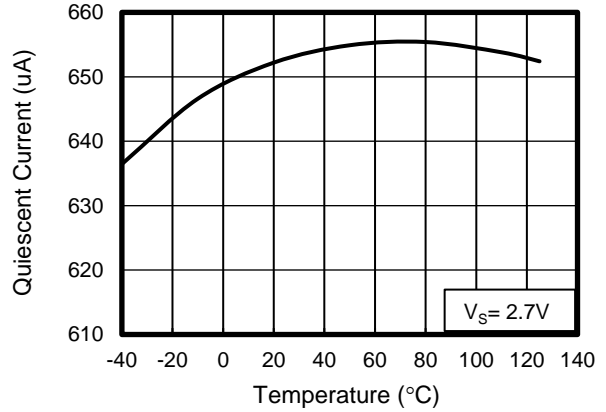


Figure 8. Quiescent Current vs Temperature

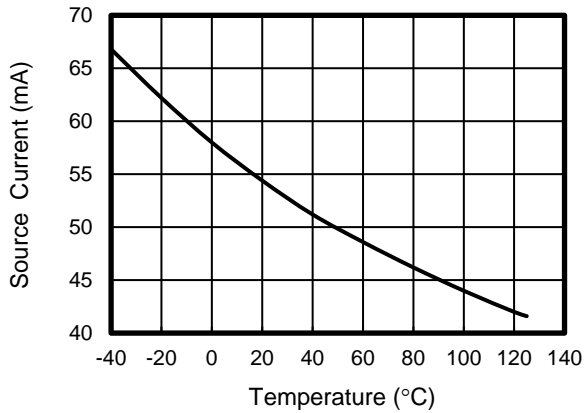


Figure 9. Source Current vs Temperature

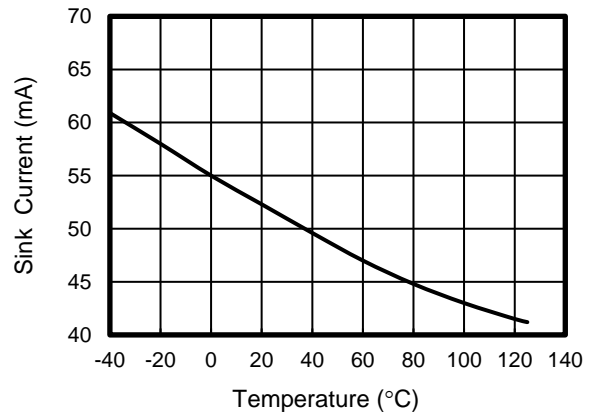


Figure 10. Sink Current vs Temperature

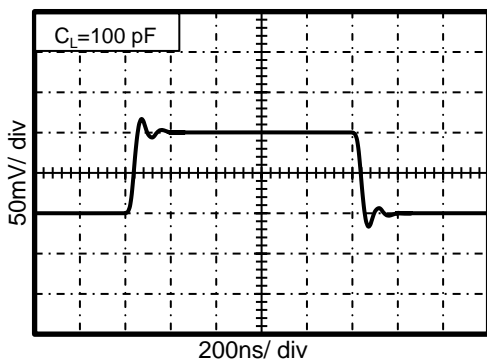


Figure 11. Small-Signal Step Response

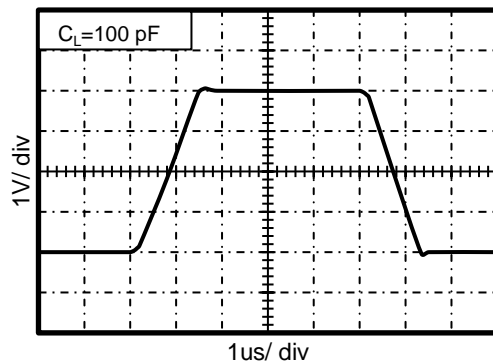


Figure 12. Large-Signal Step Response

TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

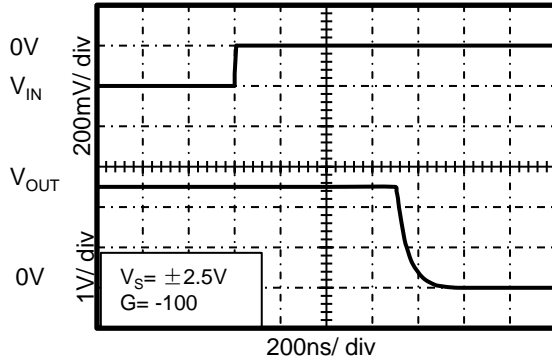


Figure 13. Positive Overvoltage Recovery

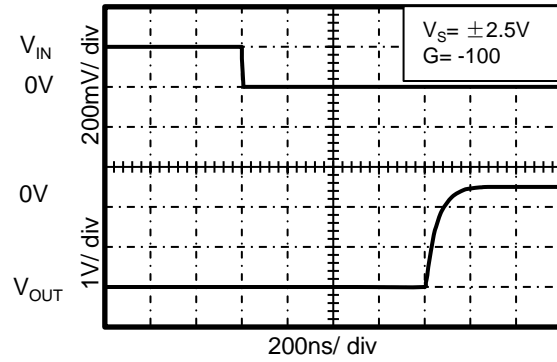


Figure 14. Negative Overvoltage Recovery

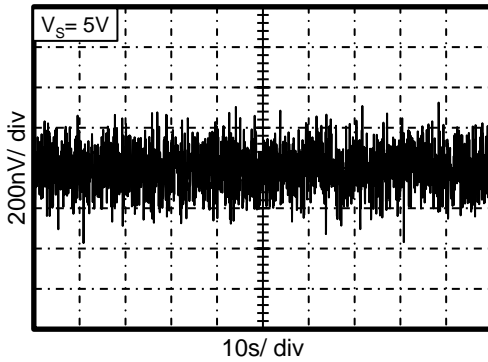


Figure 15. 0.01Hz to 10Hz Noise

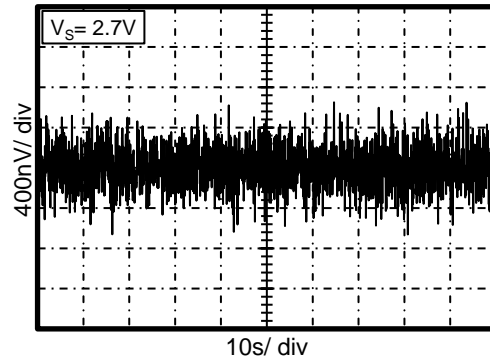


Figure 16. 0.01Hz to 10Hz Noise

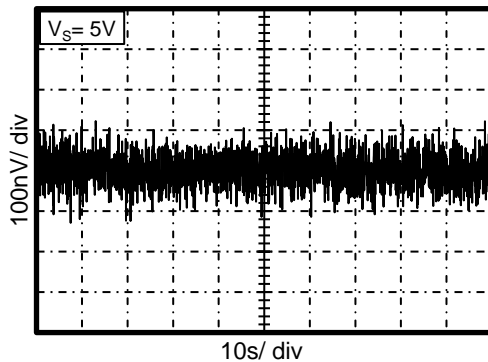


Figure 17. 0.01Hz to 1Hz Noise

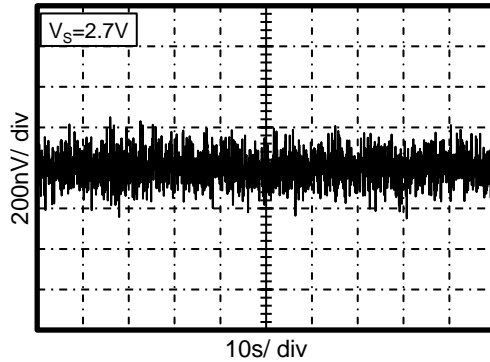


Figure 18. 0.01Hz to 1Hz Noise

Detailed Description

Overview

The RS8551, RS8552, RS8553, RS8554 series op amps are unity-gain stable and free from unexpected output phase reversal. They use auto-zeroing techniques to provide low offset voltage and very low drift over time and temperature.

Good layout practice mandates use of a 0.1 μ F capacitor placed closely across the supply pins.

For lowest offset voltage and precision performance, circuit layout and mechanical conditions should be optimized. Avoid temperature gradients that create thermoelectric (Seebeck) effects in thermocouple junctions formed from connecting dissimilar conductors. These thermally-generated potentials can be made to cancel by assuring that they are equal on both input terminals.

- Use low thermoelectric-coefficient connections (avoid dissimilar metals).
- Thermally isolate components from power supplies or other heat-sources.
- Shield op amp and input circuitry from air currents, such as cooling fans.

Following these guidelines will reduce the likelihood of junctions being at different temperatures, which can cause thermoelectric voltages of 0.1 μ V/ $^{\circ}$ C or higher, depending on materials used.

OPERATING VOLTAGE

The RS8551, RS8552, RS8553, RS8554 series op amps operate over a power-supply range of +2.7V to +5.5V (\pm 1.35V to \pm 2.75V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Parameters that vary over supply voltage or temperature are shown in the Typical Characteristics section of this data sheet.

RS8553 ENABLE FUNCTION

The enable/shutdown digital input is referenced to the V- supply voltage of the amp. A logic high enables the op amp. A valid logic high is defined as > 75% of the total supply voltage. The valid logic high signal can be up to 5.5V above the negative supply, independent of the positive supply voltage. A valid logic low is defined as < 0.8V above the V- supply pin. If dual or split power supplies are used, be sure that logic input signals are properly referred to the negative supply voltage. The enable pin must be connected to a valid high or low voltage, or driven, not left open circuit.

The logic input is a high-impedance CMOS input, with separate logic inputs provided on the dual version. For battery operated applications, this feature can be used to greatly reduce the average current and extend battery life.

The enable time includes one full autozero cycle required by the amplifier to return to V_{OS} accuracy. Prior to this time, the amplifier functions properly, but with unspecified offset voltage.

Disable time is 1 μ s. When disabled, the output assumes a high-impedance state. This allows the RS8553 to be operated as a gated amplifier, or to have the output multiplexed onto a common analog output bus.

APPLICATION NOTE

The RS855X is a unity-gain stable, precision operational amplifier with very low offset voltage drift; these devices are also free from output phase reversal. Applications with noisy or high-impedance power supplies require decoupling capacitors close to the device power-supply pins. In most cases, 0.1- μ F capacitors are adequate.

Typical Applications

Bidirectional Current-Sensing

This single-supply, low-side, bidirectional current-sensing solution detects load currents from -1A to 1A. The single-ended output spans from 110mV to 3.19V. This design uses the RS855X because of its low offset voltage and rail-to-rail input and output. One of the amplifiers is configured as a difference amplifier and the other provides the reference voltage.

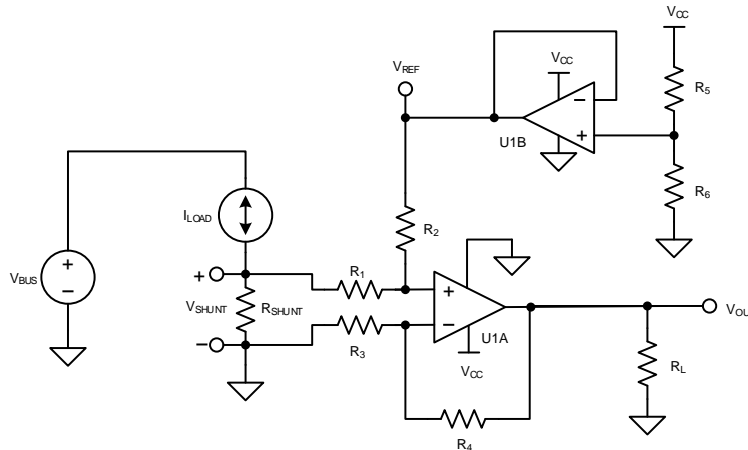


Figure 19. Bidirectional Current-Sensing Schematic

Design Requirements

This solution has the following requirements:

- Supply voltage: 3.3 V
- Input: -1 A to 1 A
- Output: 1.65 V \pm 1.54 V (110 mV to 3.19 V)

Detailed Design Procedure

The load current, I_{LOAD} , flows through the shunt resistor (R_{SHUNT}) to develop the shunt voltage, V_{SHUNT} . The shunt voltage is then amplified by the difference amplifier, which consists of U1A and R_1 through R_4 . The gain of the difference amplifier is set by the ratio of R_4 to R_3 . To minimize errors, set $R_2 = R_4$ and $R_1 = R_3$. The reference voltage, V_{REF} , is supplied by buffering a resistor divider using U1B. The transfer function is given by Equation 1.

$$V_{OUT} = V_{SHUNT} \times \text{Gain}_{\text{Diff_Amp}} + V_{REF}$$

Where

$$V_{SHUNT} = I_{LOAD} \times R_{SHUNT}$$

$$\text{Gain}_{\text{Diff_Amp}} = \frac{R_4}{R_3}$$

$$V_{REF} = V_{CC} \times \left(\frac{R_6}{R_5 + R_6} \right)$$

(1)

There are two types of errors in this design: offset and gain. Gain errors are introduced by the tolerance of the shunt resistor and the ratios of R_4 to R_3 and, similarly, R_2 to R_1 . Offset errors are introduced by the voltage divider (R_5 and R_6) and how closely the ratio of R_4/R_3 matches R_2/R_1 . The latter value impacts the CMRR of the difference amplifier, which ultimately translates to an offset error. Because this is a low-side measurement, the value of V_{SHUNT} is the ground potential for the system load. Therefore, it is important to place a maximum value on V_{SHUNT} . In this design, the maximum value for V_{SHUNT} is set to 100 mV. Equation 2 calculates the maximum value of the shunt resistor given a maximum shunt voltage of 100 mV and maximum load current of 1 A.

$$R_{SHUNT(\text{Max})} = \frac{V_{SHUNT(\text{Max})}}{I_{LOAD(\text{Max})}} = \frac{100 \text{ mV}}{1 \text{ A}} = 100 \text{ m}\Omega$$

(2)

APPLICATION NOTE

The tolerance of R_{SHUNT} is directly proportional to cost. For this design, a shunt resistor with a tolerance of 0.5% was selected. If greater accuracy is required, select a 0.1% resistor or better.

The load current is bidirectional; therefore, the shunt voltage range is -100 mV to 100 mV. This voltage is divided down by R_1 and R_2 before reaching the operational amplifier, U1A. Take care to ensure that the voltage present at the noninverting node of U1A is within the common-mode range of the device. Therefore, it is important to use an operational amplifier, such as the RS855X, that has a common-mode range that extends below the negative supply voltage. Finally, to minimize offset error, note that the RS855X has a typical offset voltage of $\pm 1\mu\text{V}$ ($\pm 5\mu\text{V}$ maximum). Given a symmetric load current of -1 A to 1 A, the voltage divider resistors (R_5 and R_6) must be equal. To be consistent with the shunt resistor, a tolerance of 0.5% was selected. To minimize power consumption, 10k Ω resistors were used. To set the gain of the difference amplifier, the common-mode range and output swing of the RS855X must be considered. Equation 3 and Equation 4 depict the typical common-mode range and maximum output swing, respectively, of the RS855X given a 3.3V supply.

$$-100\text{mV} < V_{CM} < 3.4\text{V} \quad (3)$$

$$100\text{mV} < V_{OUT} < 3.2\text{V} \quad (4)$$

The gain of the difference amplifier can now be calculated as shown in Equation 5.

$$\text{Gain}_{\text{Diff_Amp}} = \frac{V_{OUT_Max} - V_{OUT_Min}}{R_{SHUNT} \times (I_{MAX} - I_{MIN})} = \frac{3.2\text{V} - 100\text{mV}}{100\text{m}\Omega \times [1\text{A} - (-1\text{A})]} = 15.5 \frac{\text{V}}{\text{V}} \quad (5)$$

The resistor value selected for R_1 and R_3 was 1k Ω . 15.4k Ω was selected for R_2 and R_4 because it is the nearest standard value. Therefore, the ideal gain of the difference amplifier is 15.4 V/V.

The gain error of the circuit primarily depends on R_1 through R_4 . As a result of this dependence, 0.1% resistors were selected. This configuration reduces the likelihood that the design requires a two-point calibration. A simple one-point calibration, if desired, removes the offset errors introduced by the 0.5% resistors.

Application Curve

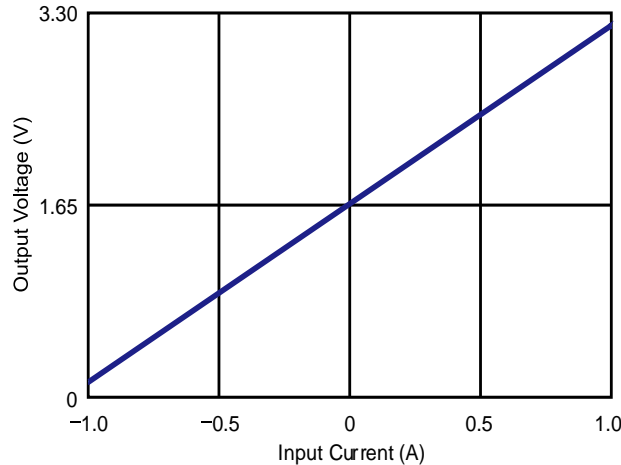


Figure 20. Bidirectional Current-Sensing Circuit Performance: Output Voltage vs Input Current

LAYOUT

Layout Guidelines

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

Layout Example

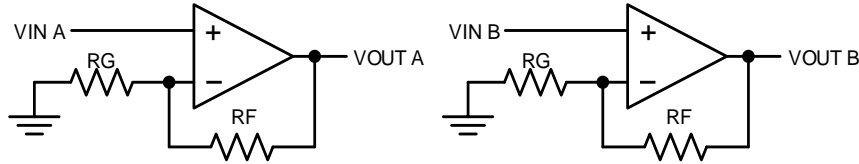


Figure 21. Schematic Representation

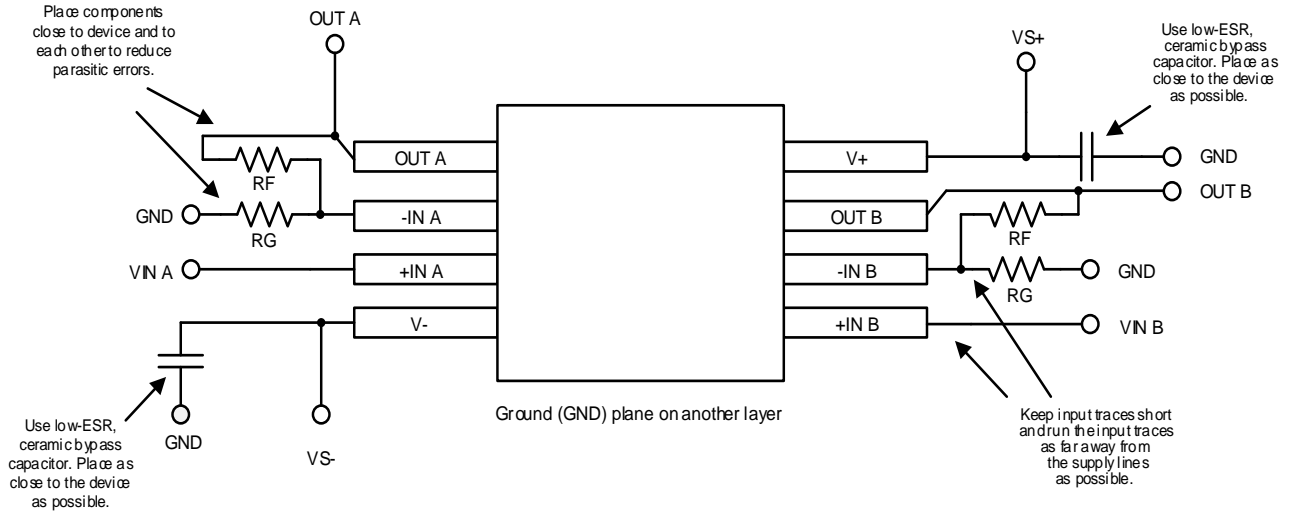
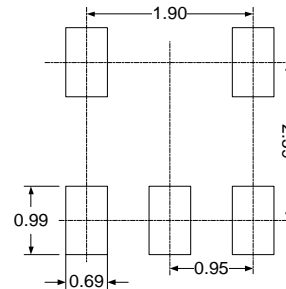
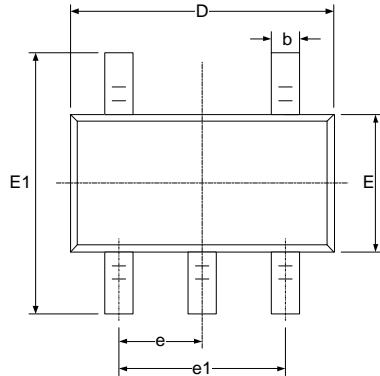
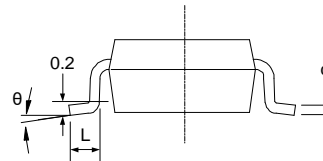
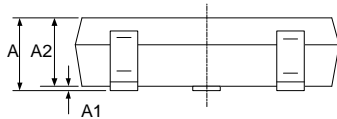
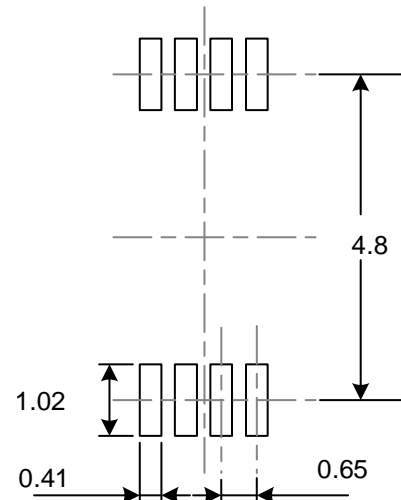
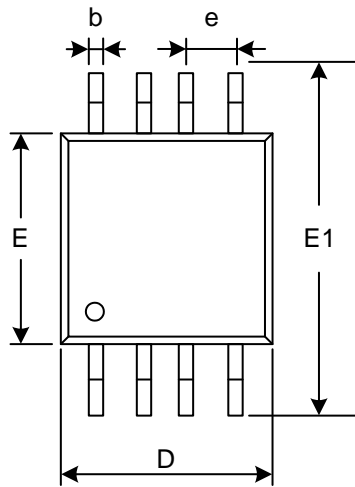


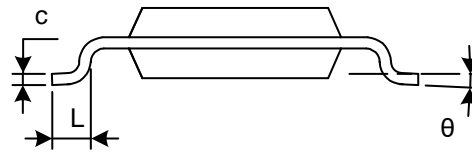
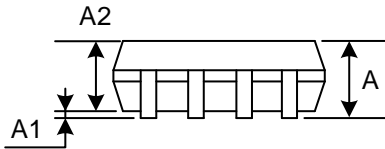
Figure 22. Layout Example

PACKAGE OUTLINE DIMENSIONS
SOT23-5

RECOMMENDED LAND PATTERN (Unit: mm)


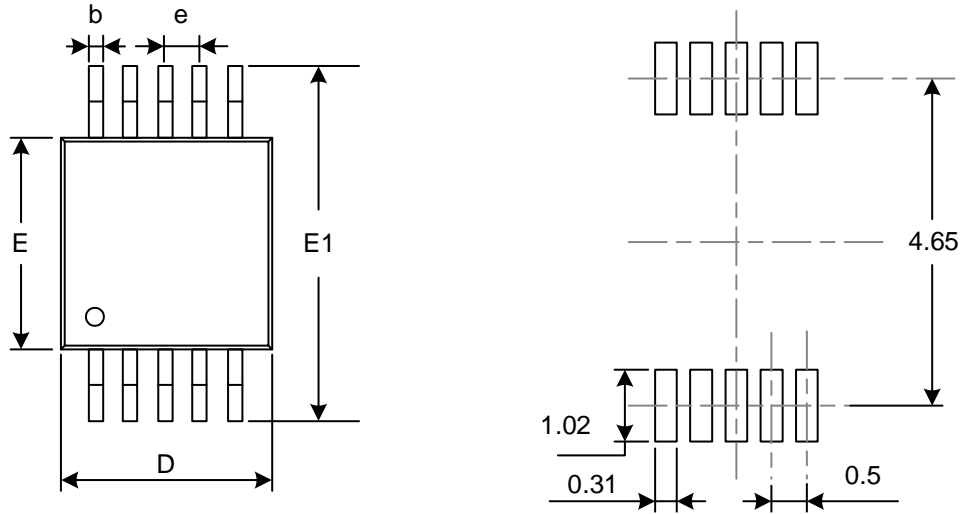
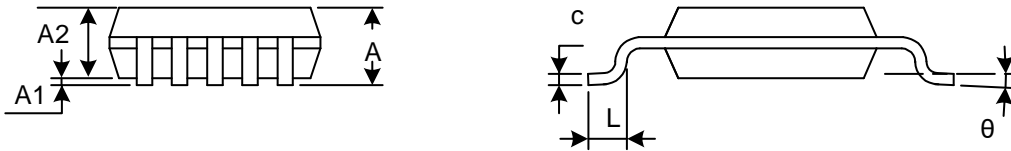
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

MSOP-8


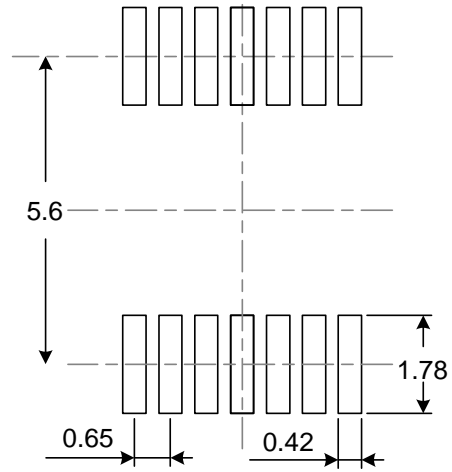
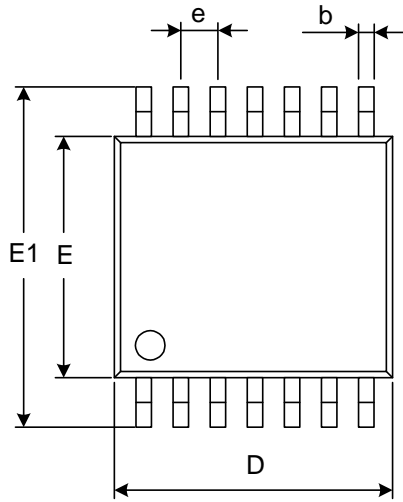
RECOMMENDED LAND PATTERN (Unit: mm)



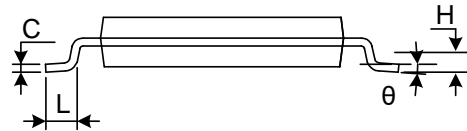
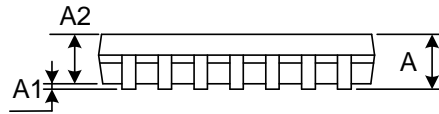
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650 (BSC)		0.026 (BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

MSOP-10

RECOMMENDED LAND PATTERN (Unit: mm)


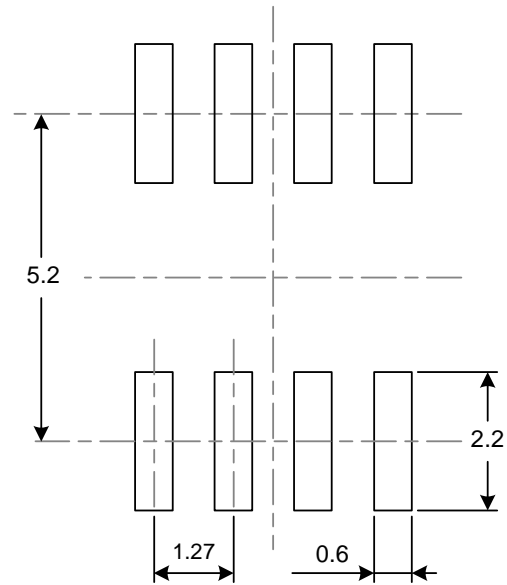
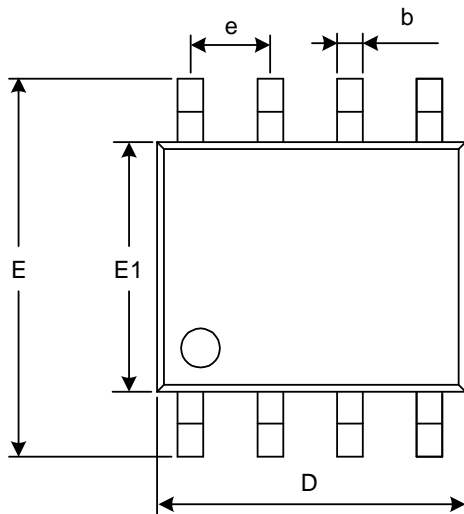
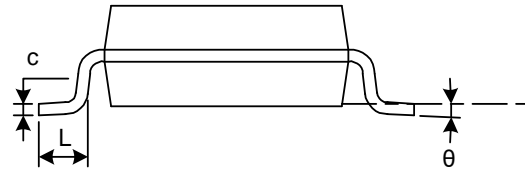
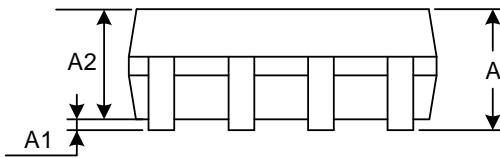
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.50 (BSC)		0.020 (BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TSSOP-14


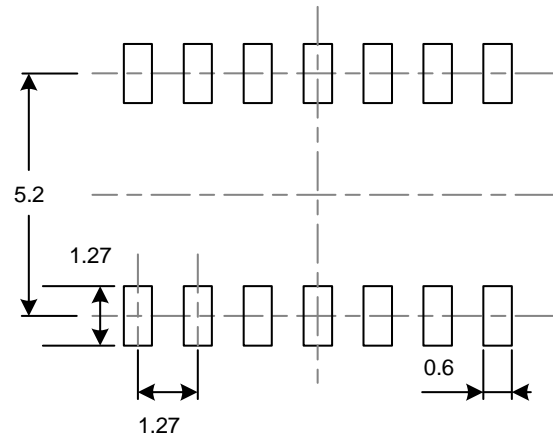
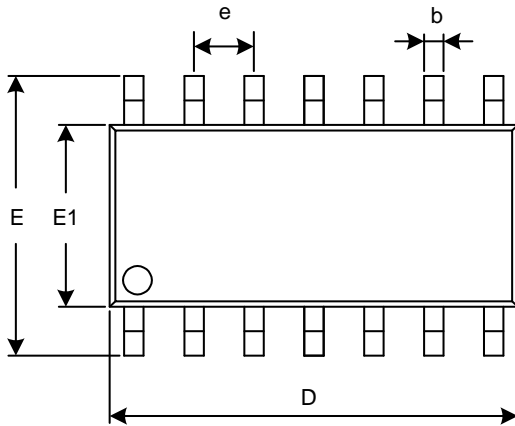
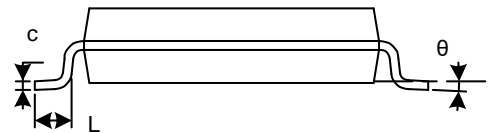
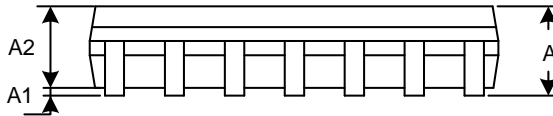
RECOMMENDED LAND PATTERN (Unit: mm)



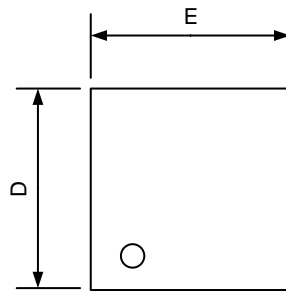
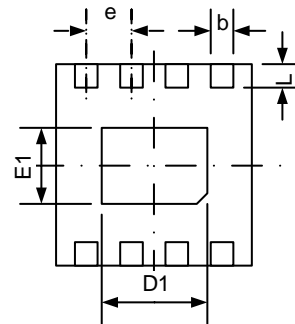
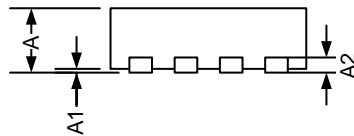
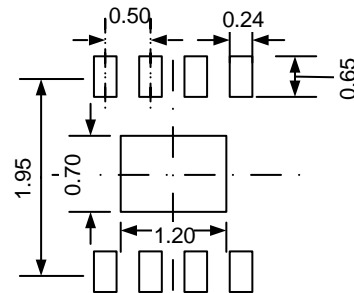
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25 (TYP)		0.01 (TYP)	
θ	1°	7°	1°	7°

SOIC-8 (SOP8)

RECOMMENDED LAND PATTERN (Unit: mm)


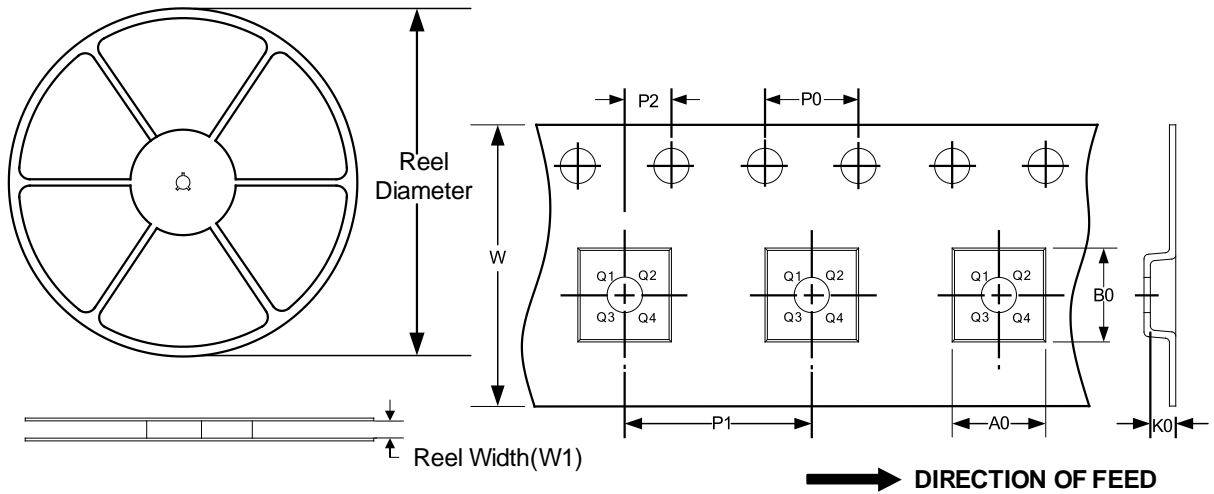
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOIC-14 (SOP14)

RECOMMENDED LAND PATTERN (Unit: mm)


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

DFN-2x2-8L

TOP VIEW

BOTTOM VIEW

SIDE VIEW

RECOMMENDED LAND PATTERN
(Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 (TYP)		0.008 (TYP)	
b	0.180	0.300	0.007	0.012
D	1.900	2.100	0.075	0.083
D1	1.100	1.300	0.043	0.051
E	1.900	2.100	0.075	0.083
E1	0.600	0.800	0.024	0.031
e	0.500 (TYP)		0.020 (TYP)	
L	0.250	0.450	0.010	0.018

TAPE AND REEL INFORMATION
REEL DIMENSIONS
TAPE DIMENSION


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
MSOP8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1
TSSOP14	13"	12.4	6.95	5.60	1.20	4.0	8.0	2.0	12.0	Q1
SOIC-8 (SOP8)	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
SOIC-14 (SOP14)	13"	16.4	6.60	9.30	2.10	4.0	8.0	2.0	16.0	Q1
MSOP-10	13"	12.4	5.20	3.30	1.20	4.0	8.0	2.0	12.0	Q1
DFN2x2-8L	7"	9.5	2.30	2.30	1.10	4.0	4.0	2.0	8.0	Q2

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